

C1210C273GATACTU

Specifications

Insulation Resistance

Aliases (C1210C273GATAC7800) SMD Comm X8G HT150C, Ceramic, 0.027 uF, 2%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	40 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1210
L	3.2mm +/-0.2mm
W	2.5mm +/-0.2mm
Т	1.25mm +/-0.15mm
S	1.5mm MIN
В	0.5mm +/-0.25mm

0.027 uF
1 kHz 1.0Vrms
2%
250 VDC
625 VDC
-55/+150°C
X8G
30 ppm/C, 1kHz 1.0Vrms
0.1% 1 kHz 1.0Vrms
0% Loss/Decade Hour: Referee Time is 1000 Hours

37.037 GOhms

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500

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